

## Preliminary

## Overview

LC573104A and LC573102A are CMOS 4-bit microcontrollers featuring low-voltage operation and low power dissipation.
Both LC573104A and LC573102A incorporate a 4-bit parallel processing ALU, 4 K bytes $/ 2 \mathrm{~K}$ bytes ROM, a $64 \times 4$-bit RAM, a 16 -bit timer, and an infrared remote control transmission carrier output circuit.

## Applications

- Remote controller.
- Control of small measuring instruments.


## Features

- ROM : 4096×8 bits (LC573104A) $2048 \times 8$ bits (LC573102A)
- RAM : $64 \times 4$ bits
- Cycle time

| Cycle <br> time | System clock <br> generator | Oscillation <br> frequency | Supply <br> voltage |
| :---: | :--- | :---: | :---: |
| $17.6 \mu \mathrm{~s}$ | Ceramic oscillation <br> circuit | 455 kHz | 2.3 to 6.0 V |

- Current Drain
a. At normal operation

| Current <br> drain | System clock <br> generator | Oscillation <br> frequency | Supply <br> voltage |
| :---: | :---: | :---: | :---: |
| $150 \mu \mathrm{~A}$ typ | CR oscillation | 455 kHz | 3.0 V |
| $400 \mu \mathrm{~A}$ typ | CR oscillation | 455 kHz | 5.0 V |

b. HALT mode

| Current <br> drain | System clock <br> generator | Oscillation <br> frequency | Supply <br> voltage |
| :---: | :---: | :---: | :---: |
| $80 \mu \mathrm{~A}$ typ | CR oscillation | 455 kHz | 3.0 V |
| $300 \mu \mathrm{~A}$ typ | CR oscillation | 455 kHz | 5.0 V |

c. HOLD mode

| Leakage <br> current | Condition | Oscillation <br> frequency | Supply <br> voltage |
| :---: | :---: | :---: | :---: |
| $0.1 \mu \mathrm{~A}$ typ | When CR oscillation <br> is at STOP mode | 455 kHz | 5.0 V |

## Package Dimensions

unit:mm
3112A-MFP24S
[LC573104A, 573102A]


SANYO : MFP24S

## Pin Assignment



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- Port
- Input port (S port, M port) : 2-port (8 pins) [Key scan input port]
- Input/Ouput port :
P0 port, P1 port 2-port (8 pins)

P2 port 1-port (2 pins) [Key scan expansion port]

- Infrared remote control carrier generation circuit.
- Software-controllable remote control carrier output ON/OFF.
- Software-controllable carrier frequency and duty ratio.
< $38 \mathrm{kHz}-1 / 3$ duty, $38 \mathrm{kHz}-1 / 2$ duty, $57 \mathrm{kHz}-1 / 2$ duty>
(When fixed carrier signal is output, it is specified by mask option)
$\cdot 1 \mathrm{kHz}$ to 200 kHz infrared remote control transmission carrier frequency.
(When carrier output is selected by timer at mask option, and when 455 kHz CR oscillator is used)
- Infrared carrier output-dedicated terminal built-in (CA terminal).
$\cdot 108 \mathrm{~ms}$ HALT-mode cancel signal output.
- Timer
- 16-bit software-controllable Timer

Timer input clock : Ceramic (CR) oscillation frequency ( 455 kHz ).
$\cdot 108 \mathrm{~ms}$ HALT release request signal generation timer (Free running timer).

- Watchdog timer (changed over between USED/UNUSED by mask option)
- Sub-routine stack level
. 2 levels
- Oscillation circuit
- Ceramic (CR) oscillation circuit : 455 kHz (for System clock generation), Feedback resistor built-in.
- Standby function
- HALT mode

HALT mode used to reduce current drain.
HALT mode suspends program execution.
Following shows how to release the HALT mode.
(A) System reset
(B) HALT mode release request signal.

- HOLD mode

HOLD mode stops ceramic resonator (CR). The HOLD mold can be released in two ways.
(A) System reset
(B) Apply H level input to S port pin or M port pin. (However, it is necessary to set S port or M port HOLD mode release permission flag beforehand.)

- From of shipment
- MFP-24S (1.0mm pitch) and chip.

NOTE : When dipping in solder to mount the MFP package on board, contact SANYO for instructions.

## The Application Development System for the LC573100 Series.

(1) Manual
(A) Users Manual : LC573100 Series Users Manual.
(B) Development Tool Manual : LC573100 Series Development Tool Manual.
(2) Development Tools

- Tools for application development of the LC573100 Series.
(A) Personal computer (MS-DOS based).
(B) Cross assembler (LC573100.EXE).
(C) Mask option generator (SU573100.EXE).
- Tools to evaluate application development of the LC573100 Series.
(A) EVA chip (LC5797).

NOTE 1) As RAM capacity differs between EVA chip (LC5797) and the LC573100 Series, always check before programming and debugging.
LC573100 : $64 \times 4$ bits
LC5797: $256 \times 4$ bits
NOTE 2) Always keep the DPH value in mind when programming. Only DPH ' 0 ' to ' 3 ' may be used as the RAM address.
If DPH other than ' 0 ' to ' 3 ' is used as RAM address when programming, SANYO will not be liable for any trouble caused.
(B) EVA chip board (TB5730).

NOTE) The application evaluation board is the evaluation board made by the user.
(C) Evaluation board [EVA420 (Monitor ROM : ER-573000)]
(D) Display and mask option data control board [DCB-1A (REV3.6)]

## Development Support System Outline


(A) Block Diagram
(LC573104A)


## Die Specifications

Chip size: $\quad 3.51 \mathrm{~mm} \times 3.19 \mathrm{~mm}$
Chip thickness : $\quad 480 \mu \mathrm{~m}$
Pad size : $\quad 120 \mu \mathrm{~m} \times 120 \mu \mathrm{~m}$

Pad Layout


Pad coordinates

| MFP24S pin assignment |  |  |  |  |
| ---: | ---: | :--- | :--- | :--- |
|  | Pad <br> No. | Pin <br> Name | X <br> $(\mu \mathrm{m})$ | Y <br> $(\mu \mathrm{m})$ |
| 17 | 1 | VDD | 1465 | 1365 |
| 18 | 2 | CA | 1155 | 1365 |
| 19 | 3 | P20 | -305 | 1365 |
| 20 | 4 | P21 | -1485 | 1365 |
| 21 | 5 | P00 | -1485 | 1110 |
| 22 | 6 | P01 | -1485 | 870 |
| 23 | 7 | P02 | -1485 | 565 |
| 24 | 8 | P03 | -1485 | 325 |
| 1 | 9 | P10 | -1485 | 20 |
| 2 | 10 | P11 | -1485 | -220 |
| 3 | 11 | P12 | -1485 | -480 |
| 4 | 12 | P13 | -1485 | -1395 |
| 5 | 13 | S1 | -410 | -1395 |


| MFP24S pin assignment |  |  |  |  |
| ---: | ---: | :--- | ---: | ---: |
|  | Pad <br> No. | Pin <br> Name | X <br> $(\mu \mathrm{m})$ | Y <br> $(\mu \mathrm{m})$ |
| 6 | 14 | S2 | 360 | -1395 |
| 7 | 15 | S3 | 560 | -1395 |
| 8 | 16 | S4 | 760 | -1395 |
| - | 17 | TEST | 960 | -1395 |
| - | 18 | TEST | 1140 | -1395 |
| 9 | 19 | M1 | 1560 | -1395 |
| 10 | 20 | M2 | 1560 | -905 |
| 11 | 21 | M3 | 1560 | -685 |
| 12 | 22 | M4 | 1560 | -445 |
| 13 | 23 | $\overline{R E S}$ | 1465 | 330 |
| 14 | 24 | VSS | 1465 | 570 |
| 15 | 25 | CF1 | 1465 | 755 |
| 16 | 26 | CF2 | 1465 | 1155 |

- The chip center is the origin of the above pad coordinates.

The X, Y values represent the coordinate of the pad center.

- When dipping the MFP24S package in solder to mount on boards, contact SANYO for instructions, etc.
- Chip substrate should be connected to $\mathrm{V}_{\mathrm{SS}}$ or left open.

Pin Function

| MFP24S <br> Pin No. | Pin name | Input/ Output | Function description | Option | Reset status |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 17 | $V_{\text {DD }}$ | - | Supply voltage. See Fig 1. |  |  |
| 14 | $V_{S S}$ | - | Ground. See Fig 1. |  |  |
| 15 | CF1 | Onput | User for system clock oscillation. <br> - 455 kHz ceramic resonator is connected between CF1 and CF2 for oscillation. <br> - Stops oscillation when receiving CR oscillation stop command. |  |  |
| 5 6 7 8 | $\begin{aligned} & \text { S1 } \\ & \text { S2 } \\ & \text { S3 } \\ & \text { S4 } \end{aligned}$ | Input | Input port S. <br> - LSI system is reset by charging VDD to S1 to S4 simultaneously (Mask option). <br> - Data is loaded in accumulator. | (1) 'L' level HOLD Tr YES/NO <br> (2) Reset by S 1 to S 4 . | - Pull-down resistor ON. <br> - Reset signal ENABLE. |
| $\begin{array}{\|l\|} \hline 9 \\ 10 \\ 11 \\ 12 \end{array}$ | $\begin{aligned} & \mathrm{M} 1 \\ & \text { M2 } \\ & \text { M3 } \\ & \text { M } \end{aligned}$ | Input | Input port M. <br> Data loaded in accumulator. | 'L' level HOLD $\operatorname{Tr}$ YES/NO | - Pull-down resistor ON. |
| $\begin{aligned} & 21 \\ & 22 \\ & 23 \\ & 24 \end{aligned}$ | $\begin{aligned} & \mathrm{P} 00 \\ & \mathrm{P} 01 \\ & \mathrm{P} 02 \\ & \mathrm{P} 03 \end{aligned}$ | Input/ Output | Input/output port. <br> - Data loaded in accumulator. <br> - Output pin to output data from accumulator. (P-ch Open Drain Output) |  |  |
| 2 3 4 | $\begin{aligned} & \text { P10 } \\ & \text { P11 } \\ & \text { P12 } \\ & \text { P13 } \end{aligned}$ | Input/ Output | Input/output port. <br> - Data loaded in accumulator. <br> - Output pin to output data from accumulator. (P-ch Open Drain Output) |  |  |
|  | $\begin{aligned} & \mathrm{P} 20 \\ & \mathrm{P} 21 \end{aligned}$ | Input/ <br> Output | Input/output port. <br> - Data loaded in accumulator. <br> - Output pin to output data from accumulator. (P-ch Open Drain Output) <br> - LED direct drivable pin. |  |  |
| 18 | CA | Output | Remote control carrier output. | Fixed carrier output/ Carrier output by timer | - At reset 'L' level. <br> - At fixed carrier output $38 \mathrm{kHz}-1 / 3$ duty. |
| 13 | $\overline{\text { RES }}$ | Input | Reset input. Internal pull-up resistor. |  |  |

## Supply connections



Fig. 1 Supply connections

## Mask Option

## (1) Input port option

| Option | Circuit | Remarks |
| :---: | :---: | :---: |
| 'L' level Hold Tr selection |  | Next port switches over in sequence. <br> - S1 to S4, M1 to M4 Input signal level Hold Tr selection <br> - 'L' level Hold Tr used. <br> - 'L' level Hold Tr not used. |

(2) Reset signal option by S port

| Option | Circuit | Remarks |
| :---: | :---: | :---: |
| Resetting IC by S port |  | Selects signal for resetting IC system by simultaneously charging 'H' level to S1 to S4. <br> - Allow <br> - Prohibit |

(3) Carrier standard clock generation circuit option for remote control

(4) Watchdog timer circuit option

| Option | Circuit | Remarks |
| :---: | :---: | :---: |
| Watchdog timer selection |  | Watchdog timer used/unused selection |

## Specifications

## Absolute Maximum Ratings

| Parameter | Symbol | Conditions | Ratings | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Supply voltage | $V_{\text {DD }}$ |  | -0.3 to +7.0 | V |
|  | $\mathrm{V}_{\text {DD1 }}$ |  | -0.3 to $\mathrm{V}_{\mathrm{DD}}$ | V |
|  | $\mathrm{V}_{\text {DD2 }}$ |  | -0.3 to $\mathrm{V}_{\mathrm{DD}}$ | V |
| Input voltage | $\mathrm{V}_{\mathrm{IN}}$ | S1 to S4, M1 to M4, RES, P00 to P03, P10 to P13, P20, P21, CF1 (P00 to P03, P10 to P13, P20, P21 are input mode) | -0.3 to $\mathrm{V}_{\mathrm{DD}}+0.3$ | V |
| Output voltage | V OUT | CA, P00 to P03, P10 to P13, P20, P21, CF2 (P00 to P03, P10 to P13, P20, P21 are output mode) | -0.3 to $\mathrm{V}_{\mathrm{DD}}+0.3$ | V |
| Output current (Per 1 pin) | IOUT1 | CA (per 1 pin) | 25 | mA |
|  | IOUT2 | P00 to P03, P10 to P13 (per 1 pin) | 500 | $\mu \mathrm{A}$ |
|  | IOUT3 | P20, P21 (Per 1 pin) | 10 | mA |
|  | IOUT4 | Output pins other than listed above (per 1 pin) | 500 | $\mu \mathrm{A}$ |
| Total output current of all pins except CA | IALL | All pins totaled (except for CA pin) | 25 | mA |
| Operating temperature | Topr |  | -30 to +70 | ${ }^{\circ} \mathrm{C}$ |
| Storage temperature | Tstg |  | -40 to +125 | ${ }^{\circ} \mathrm{C}$ |

Recommended Operating Ranges at $\mathrm{Ta}=-30$ to $+70^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}$

| Parameter | Symbol | Conditions | Ratings |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | min | typ | max |  |
| Supply voltage | $\mathrm{V}_{\text {DD }}$ |  | 2.3 |  | 6.0 | V |
| Input high-level voltage | $\mathrm{V}_{\mathrm{IH} 1}$ | S1 to S4, M1 to M4, P00 to P03, P10 to P13, P20, P21 (P0, P1, P2 ports are input mode) | $0.7 \mathrm{~V}_{\mathrm{DD}}$ |  | $\mathrm{V}_{\mathrm{DD}}$ | V |
| Input low-level voltage | $\mathrm{V}_{\text {IL1 }}$ |  | 0 |  | $0.3 \mathrm{~V}_{\mathrm{DD}}$ | V |
| Input high-level voltage | $\mathrm{V}_{\text {IH2 }}$ | $\overline{R E S}$ | $0^{0.75 V_{\text {D }}}$ |  | $\mathrm{V}_{\mathrm{DD}}$ | V |
| Input low-level voltage | $\mathrm{V}_{\text {IL2 }}$ |  | 0 |  | $0.25 \mathrm{~V}_{\mathrm{DD}}$ | V |
| Operation frequency | ${ }^{\text {foPG }}$ | At CR oscillation, Fig. 2 | 380 | 455 | 500 | kHz |



Fig. 2 CR Oscillation Circuit

Electrical Characteristics at $\mathrm{Ta}=-30$ to $+70^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}$

| Parameter | Symbol | Conditions |  | Ratings |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | min | typ | max |  |
| Input impedance | $\mathrm{R}_{\text {IN }}{ }^{1 /}$ | $\mathrm{V}_{\mathrm{DD}}=2.9 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0.4 \mathrm{~V}$, S1 to S 4 , M1 to M4, 'L' level Hold Tr, Fig. 3 |  | 150 | 300 | 1000 | k $\Omega$ |
|  | $\mathrm{R}_{\text {IN }}{ }^{1 B}$ | $\mathrm{V}_{\mathrm{DD}}=2.9 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0.4 \mathrm{~V}$, S1 to S4, M1 to M4, 'L' level pull-down Tr, Fig. 3 |  | 30 | 50 | 100 | k $\Omega$ |
|  | $\mathrm{R}_{\mathrm{IN}}{ }^{2}$ | $\mathrm{V}_{\mathrm{DD}}=2.9 \mathrm{~V}, \overline{\mathrm{RES}}$ |  | 10 |  | 300 | k $\Omega$ |
| Output high-level voltage | $\mathrm{V}_{\mathrm{OH}}{ }^{1}$ | $\mathrm{V}_{\mathrm{DD}}=2.9 \mathrm{~V}, \mathrm{I}_{\mathrm{OH}}=-450 \mu \mathrm{~A}, \mathrm{P} 00$ to P03, P10 to P13 |  | $\mathrm{V}_{\mathrm{DD}}{ }^{-0.45}$ |  |  | V |
| Output off-leak current | \| I OFF ${ }^{\text {\| }}$ | $\mathrm{V}_{\mathrm{DD}}=2.9 \mathrm{~V}, \mathrm{P} 00$ to $\mathrm{P} 03, \mathrm{P} 10$ to P 13 | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {SS }}$ |  |  | 1.0 | $\mu \mathrm{A}$ |
|  | $\|\mathrm{IOFF}\|$ |  | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {DD }}$ | -1.0 |  |  | $\mu \mathrm{A}$ |
| Output high-level voltage | $\mathrm{V}_{\mathrm{OH}}{ }^{2}$ | $\mathrm{V}_{\mathrm{DD}}=2.9 \mathrm{~V}, \mathrm{I}_{\mathrm{OH}}=-10 \mathrm{~mA}, \mathrm{P} 20, \mathrm{P} 21$ |  | $\mathrm{V}_{\mathrm{DD}}{ }^{-0.5}$ |  |  | V |
| Output off-leak current | \| IOFF | | $\mathrm{V}_{\mathrm{DD}}=2.9 \mathrm{~V}, \mathrm{P} 20, \mathrm{P} 21$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {SS }}$ |  |  | 1.0 | $\mu \mathrm{A}$ |
|  | \| IOFF ${ }^{\text {\| }}$ |  | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {DD }}$ | -1.0 |  |  | $\mu \mathrm{A}$ |
| Output current (H) | ${ }^{1} \mathrm{OH}^{1}$ | $\mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{OH}}=\mathrm{V}_{\mathrm{DD}}-1.5 \mathrm{~V}, \mathrm{CA}$ |  | 6 | 12 |  | mA |
| Output current (L) | ${ }^{\text {I OL }}{ }^{1}$ | $\mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{OH}}=0.9 \mathrm{~V}, \mathrm{CA}$ |  | 2 | 5 |  | mA |
| HALT-mode supply current | 'DD1 | $\mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}, 455 \mathrm{kHz}$ CR oscillation, $\mathrm{Ccd}=\mathrm{Ccg}=150 \mathrm{pF}$, $\mathrm{Ta} \leq 50^{\circ} \mathrm{C}$, Fig. 5 |  |  | 80 | 300 | $\mu \mathrm{A}$ |
| Operating current | ${ }^{\prime} \mathrm{DD}^{2}$ | $\mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}, 455=\mathrm{kHz}$ CR oscillation, $\mathrm{Ccd}=\mathrm{Ccg}=150 \mathrm{pF}$, $\mathrm{Ta} \leq 50^{\circ} \mathrm{C}$, Fig. 5 |  |  | 150 | 500 | $\mu \mathrm{A}$ |
| Supply leak current 1 | l $\mathrm{LEAK}^{1}$ | $\mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}$ | $\mathrm{Ta}=25^{\circ} \mathrm{C}$ |  | 0.2 | 1 | $\mu \mathrm{A}$ |
| Supply leak current 2 | l LEAK $^{2}$ |  | $\mathrm{Ta}=50^{\circ} \mathrm{C}$ |  | 1 | 5 | $\mu \mathrm{A}$ |
| Oscillator start-up voltage | $\mathrm{V}_{\text {ST }}$ | Ccd=Ccg=150pF, 455kHz CR oscillation, Fig. 4 |  |  |  | 2.3 | V |
| Oscillator sustaining voltage | $\mathrm{V}_{\text {SUS }}$ |  |  | 2.0 |  |  | V |
| Oscillator start-up time | tst | $\mathrm{V}_{\mathrm{DD}}=2.3 \mathrm{~V}, \mathrm{Ccd}=\mathrm{Ccg}=150 \mathrm{pF}, 455 \mathrm{kHz}$ CR oscillation, Fig. 4 |  |  |  | 30 | ms |

Recommended Oscillators.

| Oscillator | Manufacturer | Part number | Ccg | Ccd |
| :---: | :--- | :--- | :---: | :---: |
| 455 kHz <br> osceillator | Kyocera | KBR-455BK/Y | 150 pF | 150 pF |
|  | Murata | CSB455E | 150 pF | 150 pF |
|  | Fuji Ceramics | POE-455 | 150 pF | 150 pF |

Electrical Characteristics at $\mathrm{Ta}=-30$ to $+70^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}$

| Parameter | Symbol | Conditions |  | Ratings |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | min | typ | max |  |
| Input impedance | $\mathrm{R}_{\mathrm{IN}} 1 \mathrm{~A}$ | $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0.4 \mathrm{~V}$, S 1 to S 4 , M 1 to M 4 , 'L' level Hold Tr, Fig. 3 |  | 70 | 200 | 600 | k $\Omega$ |
|  | $\mathrm{R}_{\text {IN }}{ }^{1 B}$ | $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}$, S1 to S 4 , M1 to M4, 'L' level pull-down Tr, Fig. 3 |  | 30 | 50 | 100 | k $\Omega$ |
|  | $\mathrm{R}_{\text {IN }}{ }^{2}$ | $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}, \overline{\mathrm{RES}}$ |  | 10 |  | 300 | $\mathrm{k} \Omega$ |
| Output high-level voltage | $\mathrm{V}_{\mathrm{OH}}{ }^{1}$ | $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}, \mathrm{I}_{\mathrm{OH}}=-750 \mu \mathrm{~A}, \mathrm{P} 00$ to P03, P10 to P13 |  | $\mathrm{V}_{\mathrm{DD}}-0.75$ |  |  | V |
| Output off-leak current | $\|\mathrm{IOFF}\|$ | $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}, \mathrm{P} 00$ to $\mathrm{P} 03, \mathrm{P} 10$ to P 13 | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {SS }}$ |  |  | 1.0 | $\mu \mathrm{A}$ |
|  | $\mid \mathrm{I}$ OFF ${ }^{\text {\| }}$ |  | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {DD }}$ | -1.0 |  |  | $\mu \mathrm{A}$ |
| Output high-level voltage | $\mathrm{V}_{\mathrm{OH}}{ }^{2}$ | $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}, \mathrm{I}_{\mathrm{OH}}=-10 \mathrm{~mA}, \mathrm{P} 20, \mathrm{P} 21$ |  | $\mathrm{V}_{\mathrm{DD}}{ }^{-0.5}$ |  |  | V |
| Output off-leak current | IIOFF | $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}, \mathrm{P} 20, \mathrm{P} 21$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {SS }}$ |  |  | 1.0 | $\mu \mathrm{A}$ |
|  | \| IOFF |  | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {DD }}$ | -1.0 |  |  | $\mu \mathrm{A}$ |
| Output current (H) | ${ }^{1} \mathrm{OH}^{1}$ | $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{OH}}=\mathrm{V}_{\mathrm{DD}}-2.5 \mathrm{~V}, \mathrm{CA}$ |  | 10 | 20 |  | mA |
| Output current (L) | ${ }^{\text {I OL }}$ | $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{OL}}=0.9 \mathrm{~V}, \mathrm{CA}$ |  | 2 | 5 |  | mA |
| HALT-mode supply current | IDD1 | $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}, 455 \mathrm{kHz}$ CR oscillation, $\mathrm{Ccd}=\mathrm{Ccg}=150 \mathrm{pF}$, $\mathrm{Ta} \leq 50^{\circ} \mathrm{C}$, Fig. 5 |  |  | 300 | 400 | $\mu \mathrm{A}$ |
| Operating current | ${ }^{\text {I DD }}$ 2 | $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}, 455 \mathrm{kHz}$ CR oscillation, $\mathrm{Ccd}=\mathrm{Ccg}=150 \mathrm{pF}$, $\mathrm{Ta} \leq 50^{\circ} \mathrm{C}$, Fig. 5 |  |  | 400 | 500 | $\mu \mathrm{A}$ |
| Supply leak current 1 | 'LEAK ${ }^{1}$ | $V_{D D}=5.0 \mathrm{~V}$ | $\mathrm{Ta}=25^{\circ} \mathrm{C}$ |  | 0.2 | 1 | $\mu \mathrm{A}$ |
| Supply leak current 2 | 'LEAK ${ }^{2}$ |  | $\mathrm{Ta}=50^{\circ} \mathrm{C}$ |  | 1 | 5 | $\mu \mathrm{A}$ |
| Oscillator start-up voltage | $\mathrm{V}_{\text {ST }}$ | Ccd=Ccg=150pF, 455 kHz CR oscillation, Fig. 4 |  |  |  | 2.3 | V |
| Oscillator sustaining voltage | $\mathrm{V}_{\text {SUS }}$ |  |  | 2.0 |  |  | V |
| Oscillator start-up time | ${ }^{\text {t }}$ T $T$ | $\mathrm{V}_{\mathrm{DD}}=2.3 \mathrm{~V}, \mathrm{Ccd}=\mathrm{Ccg}=150 \mathrm{pF}, 455 \mathrm{kHz}$ CR oscillation, Fig. 4 |  |  |  | 30 | ms |



Fig. 3 : S1 to S4, M1 to M4 input structure


Fig. 5 : Supply current measuring circuit


Fig. 4 : Oscillator start-up voltage, Oscillator sustaining voltage, and Oscillator start-up time measuring circuit.

[^0]
## LC573100 Series Instruction Set

The instruction set uses the following abbreviations and symbols.

AC : Accumulator
ACn : Accumulator bit $n$
CF : Carry flag
DP : Data pointer
DPL : Data pointer low nibble
DPH : Data pointer high nibble
EDP : Data pointer save register
EDPL : Data pointer save register low nibble
EDPH : Data pointer save register high nibble
SP : Strobe pointer
TREG : Temporary register
SCFn : Start conditioning flag n
CTLn : Control register n
HEFn : Hold enable flag n
ROM : ROM data
CFCF : Ceramic resonator oscillator control flag
( ) : Contents
[ ] : Contents
$\checkmark \quad$ : Logical OR
$\forall \quad$ : Logical exclusive-OR
$\wedge \quad:$ Logical AND
$\leftarrow \quad:$ Transfer direction, result

| M | : Memory |
| :---: | :---: |
| M (DP) | : Memory addressed by DP |
| [M(DP)] | : Contents of memory addressed by DP |
| PC | : Program counter |
| PCn | : Program counter bit n |
| PAGE | : Page latch |
| STSn | : Status register n |
| (STSm) | : Status register n content |
| [P( ) ] | : Contents of port ( ) |
| X | : Immediate data |
| Xn | : Immediate data bit n |
| PDF | : Input port pull-down flag |
| SFR | : Special function register |
| (SFR) | : Contents of special function register |
| CSTF | : Chrono start flag |
| SPC | : Strobe pointer control bit |
| CCF | : Carrier output control flag |
| ( ) | : Complement of contents |
| [ ] | : Complement of contents |
| $\phi \mathrm{n}$ | : Output from stage n of 15 -stage divider |
| WDT | : Watchdog timer |

- The special function registers are abbreviated as follows.

TCON : Timer control register
TLOW : Timer/counter register low byte
THIGH : Timer/counter register high byte
CTL4 : Control register 4
P0 : Port P0
P1 : Port P1
P2 : Port P2

## LC573100 Series Instructions

|  | Mnemonic | Instruction code | Function | 愻 | $\stackrel{\varrho}{0}$ | Function description | Status flag affected |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | TAAT | $0000 \quad 0001$ | AC, TRGE $\leftarrow$ ROM | 1 | 2 | Contents of ROM on current page, addressed by PC whose low-orderd 8 bits are replaced with contents of $A C$ and $M$ (DP), are loaded to $A C$ and TREG |  |
|  | MTR | 00010010 | $\mathrm{M}(\mathrm{DP}) \leftarrow$ TREG | 1 | 1 | Stores the conternts of TREG memory location pointed to by DP. |  |
|  | ASR0 | $0001 \quad 1000$ | $\mathrm{AC}_{\mathrm{n}} \leftarrow \mathrm{AC}_{\mathrm{n}+1}, \mathrm{AC}_{3} \leftarrow 0$ | 1 | 1 | Shifts the contents of the AC right and enter 0 into the MSB. |  |
|  | ASR1 | $0001 \quad 1001$ | $\mathrm{AC}_{n} \leftarrow \mathrm{AC} \mathrm{n}_{+1}, \mathrm{AC}_{3} \leftarrow 1$ | 1 | 1 | Shifts the contents of the AC right and enter 1 into the MSB. |  |
|  | ASLO | $0001 \quad 1010$ | $A C_{n} \leftarrow A C_{n-1}, A C_{0} \leftarrow 0$ | 1 | 1 | Shifts the contents of the AC left and enter 0 into the LSB. |  |
|  | ASL1 | $0001 \quad 1011$ | $\mathrm{AC}_{\mathrm{n}} \leftarrow \mathrm{AC}_{\mathrm{n}-1}, \mathrm{AC}_{0} \leftarrow 1$ | 1 | 1 | Shifts the contents of the AC left and enter 1 into the LSB. |  |
|  | INC | $1001 \quad 1000$ | $\mathrm{AC}, \mathrm{M}(\mathrm{DP}) \leftarrow \mathrm{M}(\mathrm{DP})+1$ | 1 | 1 | Memory M (DP) contents incremented +1, and loaded to AC and M (DP). |  |
|  | DEC | $1001 \quad 1001$ | $\mathrm{AC}, \mathrm{M}(\mathrm{DP}) \leftarrow \mathrm{M}(\mathrm{DP})-1$ | 1 | 1 | Memory M (DP) contents decremented -1, and loaded to AC and M (DP). |  |
|  | ADC | 10000000 | $\mathrm{AC} \leftarrow(\mathrm{AC})+[\mathrm{M}(\mathrm{DP})]+\mathrm{CF}$ | 1 | 1 | AC, memory M (DP) and CF contents are binary-added and the result loaded to $A C$. | CF |
|  | ADC* | 10001000 | $\mathrm{AC}, \mathrm{M}(\mathrm{DP}) \leftarrow(\mathrm{AC})+[\mathrm{M}(\mathrm{DP})]+\mathrm{CF}$ | 1 | 1 | AC, memory M (DP) and CF contents are binary-added and the result loaded to $A C, M(D P)$. | CF |
|  | ADCI X | $\begin{array}{cc} 1001 & 0000 \\ ---- & x_{3} x_{2} x_{1} x_{0} \end{array}$ | $A C \leftarrow(A C)+X+C F$ | 2 | 2 | AC, immediate data and CF contents are binary-added, and the result loaded to $A C$. | CF |
|  | SBC | 10000001 | $\mathrm{AC} \leftarrow(\mathrm{AC})+[\overline{\mathrm{M}}(\mathrm{DP})]+\mathrm{CF}$ | 1 | 1 | AC, memory M (DP) and CF contents are binary-subtracted, and the result loaded to AC. | CF |
|  | SBC* | $1000 \quad 1001$ | $\mathrm{AC}, \mathrm{M}(\mathrm{DP}) \leftarrow(\mathrm{AC})+[\overline{\mathrm{M}}(\mathrm{DP})]+\mathrm{CF}$ | 1 | 1 | AC, memory M (DP) and CF contents are binary-subtracted, and the result loaded to $A C$ and $M$ (DP). | CF |
|  | SBCI X | $\begin{array}{cc} 1001 & 0001 \\ ---- & x_{3} x_{2} x_{1} x_{0} \\ \hline \end{array}$ | $A C \leftarrow(A C)+\bar{X}+C F$ | 2 | 2 | AC, immediate data and CF contents are binary-subtracted and the result loaded to AC. | CF |
|  | ADD | 10000010 | $\mathrm{AC} \leftarrow(\mathrm{AC})+[\mathrm{M}(\mathrm{DP})]$ | 1 | 1 | AC and memory M (DP) contents are binary-added and the result loaded to AC. | CF |
|  | ADD* | $1000 \quad 1010$ | $\mathrm{AC}, \mathrm{M}(\mathrm{DP}) \leftarrow(\mathrm{AC})+[\mathrm{M}(\mathrm{DP})]$ | 1 | 1 | AC and memory M (DP) contents are binary-added and the result loaded to $A C$ and $M$ (DP). | CF |
|  | ADDI X | $\begin{array}{cc} 1001 & 0010 \\ ---- & x_{3} x_{2} x_{1} x_{0} \end{array}$ | $A C \leftarrow(A C)+X$ | 2 | 2 | AC and immediate data contents are binary-added and the result loaded to AC. | CF |
|  | SUB | 10000011 | $\mathrm{AC} \leftarrow(\mathrm{AC})+[\overline{\mathrm{M}(\mathrm{DP})}]+1$ | 1 | 1 | AC and memory M (DP) contents are binary-subtracted and the result loaded to $A C$. | CF |
|  | SUB* | $1000 \quad 1011$ | $\mathrm{AC}, \mathrm{M}(\mathrm{DP}) \leftarrow(\mathrm{AC})+[\overline{\mathrm{M} \mathrm{( } \mathrm{DP)}]}+1$ | 1 | 1 | AC and memory M (DP) contents are binary-subtracted and the result loaded to $A C$ and $M$ (DP). | CF |
|  | SUBI X | 1001 0011 <br> ---- $x_{3} x_{2} x_{1} x_{0}$ | $\mathrm{AC} \leftarrow(\mathrm{AC})+\overline{\mathrm{X}}+1$ | 2 | 2 | AC and immediate data contents are binary-subtracted and the result loaded in AC. | CF |
|  | ADN | 10000100 | $\mathrm{AC} \leftarrow(\mathrm{AC})+[\mathrm{M}(\mathrm{DP})]$ | 1 | 1 | AC and memory M (DP) contents are binary-added and the result loaded to AC. |  |
|  | ADN* | 10001100 | $\mathrm{AC}, \mathrm{M}(\mathrm{DP}) \leftarrow(\mathrm{AC})+[\mathrm{M}(\mathrm{DP})]$ | 1 | 1 | AC and memory M (DP) contents are binary-added and the result loaded to $A C$ and $M$ (DP). |  |
|  | ADNI X | $\begin{array}{cc} \hline 1001 & 0100 \\ ---- & x_{3} x_{2} x_{1} x_{0} \\ \hline \end{array}$ | $A C \leftarrow(A C)+X$ | 2 | 2 | AC and immediate data contents are binary-added and the result loaded in AC. |  |
| 이 | AND | 10000101 | $\mathrm{AC} \leftarrow(\mathrm{AC}) \wedge[\mathrm{M}(\mathrm{DP})]$ | 1 | 1 | AC and memory M (DP) contents are ANDed and the result loaded to AC. |  |
|  | AND* | 10001101 | $\mathrm{AC}, \mathrm{M}(\mathrm{DP}) \leftarrow(\mathrm{AC}) \wedge[\mathrm{M}(\mathrm{DP})]$ | 1 | 1 | AC and memory M (DP) contents are ANDed and the result loaded to AC and M (DP). |  |
|  | ANDI X | 1001 0101 <br> ---- $x_{3} x_{2} x_{1} x_{0}$ | $\mathrm{AC} \leftarrow(\mathrm{AC}) \wedge \mathrm{X}$ | 2 | 2 | AC and immediate data contents are ANDed and the result loaded to AC. |  |
|  | EOR | 10000110 | $\mathrm{AC} \leftarrow(\mathrm{AC}) *[\mathrm{M}(\mathrm{DP})]$ | 1 | 1 | AC and memory M (DP) are exclusive ORed and the result loaded to AC. |  |
|  | EOR* | 10001110 | $\mathrm{AC}, \mathrm{M}(\mathrm{DP}) \leftarrow(\mathrm{AC}) \forall[\mathrm{M}(\mathrm{DP})]$ | 1 | 1 | AC and memory M (DP) are exclusive ORed, and the result loaded to AC and M (DP). |  |
|  | EORIX | $\begin{array}{cc} 1001 & 0110 \\ ---- & x_{3} x_{2} x_{1} x_{0} \end{array}$ | $A C \leftarrow(A C) \forall X$ | 2 | 2 | AC and immediate data are exclusive ORed and the result loaded to AC. |  |
|  | OR | 10000111 | $\mathrm{AC} \leftarrow(\mathrm{AC}) \vee[\mathrm{M}(\mathrm{DP})]$ | 1 | 1 | AC and memory M (DP) are ORed and the result loaded to AC. |  |
|  | OR* | $1000 \quad 1111$ | $\mathrm{AC}, \mathrm{M}(\mathrm{DP}) \leftarrow(\mathrm{AC}) \vee[\mathrm{M}(\mathrm{DP})]$ | 1 | 1 | AC and memory M (DP) are ORed and the result loaded to AC and M (DP). |  |
|  | ORI X | 1001 0111 <br> ---- $x_{3} x_{2} x_{1} x_{0}$ | $\mathrm{AC} \leftarrow(\mathrm{AC}) \vee \mathrm{X}$ | 2 | 2 | AC and immediate data are ORed and the result loaded to AC. |  |

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|  | Mnemonic | Instruction code |  | Function | ¢ | ¢ | Function description | Status flag affected |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | SDPL | 0001 | 1100 | $\mathrm{DPL} \leftarrow(\mathrm{AC})$ | 1 | 1 | AC contents loaded to DPL. |  |
|  | SDPH | 0001 | 1101 | $\mathrm{DPH} \leftarrow(\mathrm{AC})$ | 1 | 1 | AC contents loaded to DPH. |  |
|  | LDPL | 1111 | 1101 | $\mathrm{AC} \leftarrow(\mathrm{DPL})$ | 1 | 1 | DPL contents loaded to AC. |  |
|  | LDPH | 1111 | 1110 | $\mathrm{AC} \leftarrow(\mathrm{DPH})$ | 1 | 1 | DPH contents loaded to AC. |  |
|  | MDPL X | 1011 | $x_{3} x_{2} x_{1} x_{0}$ | DPL $\leftarrow \mathrm{X}$ | 1 | 1 | Immediate data X loaded to DPL. |  |
|  | MDPH X | 1100 | $\mathrm{x}_{3} \mathrm{x}_{2} \mathrm{x}_{1} \mathrm{x}_{0}$ | DPH $\leftarrow \mathrm{X}$ | 1 | 1 | Immediate data X loaded to DPH. |  |
|  | EDPL | 0001 | 1110 | (DPL) $\leftrightarrow($ EDPL) | 1 | 1 | DPL and EDPL contents exchanged. |  |
|  | EDPH | 0001 | 1111 | (DPH) $\leftrightarrow($ EDPH $)$ | 1 | 1 | DPH and EDPH contents exchanged. |  |
|  | IDPL | 1001 | 1010 | $\mathrm{DPL} \leftarrow(\mathrm{DPL})+1$ | 1 | 1 | DPL contents incremented +1. |  |
|  | IDPH | 1001 | 1100 | DPH $\leftarrow(\mathrm{DPH})+1$ | 1 | 1 | DPH contents incremented +1 . |  |
|  | DDPL | 1001 | 1011 | DPL $\leftarrow(\mathrm{DPL})-1$ | 1 | 1 | DPL contents decremented - 1 . |  |
|  | DDPH | 1001 | 1101 | DPH $\leftarrow(\mathrm{DPH})-1$ | 1 | 1 | DPH contents decremented -1. |  |
| क | SSP | 1010 | 1110 | $\mathrm{SP} \leftarrow(\mathrm{AC})$ | 1 | 1 | AC contents loaded to SP. |  |
|  | LSP | 1010 | 1010 | $\mathrm{AC} \leftarrow(\mathrm{SP})$ | 1 | 1 | SP contents loaded to AC. |  |
|  | MSP X | 1110 | $x_{3} x_{2} x_{1} x_{0}$ | $\mathrm{SP} \leftarrow \mathrm{X}$ | 1 | 1 | Immediate data X loaded to SP . |  |
|  | ISP | 1001 | 1110 | $\mathrm{SP} \leftarrow(\mathrm{SP})+1$ | 1 | 1 | SP contents incremented +1 . |  |
|  | DSP | 1001 | 1111 | $\mathrm{SP} \leftarrow(\mathrm{SP})-1$ | 1 | 1 | SP contents decremented -1. |  |
| $\begin{aligned} & \text { 希 } \\ & \hline \end{aligned}$ | LHLT | 1010 | 1011 | AC $\leftarrow$ (STS2), STS2 $\leftarrow 0$ | 1 | 1 | STS2 contents loaded to AC and STS2 is reset. | $\begin{aligned} & \text { SCF1 to } \\ & \text { SCF4 } \end{aligned}$ |
|  | L500 | 1010 | 1100 | AC $\leftarrow($ STS1), SCF0 $\leftarrow 0$ | 1 | 1 | STS1 contents loaded to AC and SCFO is reset. | SCFO |
|  | CSP | 0000 | 0100 | CSTF $\leftarrow 0$ | 1 | 1 | CSTF reset. | CSTF |
|  | CST | 0000 | 0101 | CSTF $\leftarrow 1$ | 1 | 1 | CSTF set. | CSTF |
|  | RC5 | 0000 | 0110 | HEFO $\leftarrow 0$ | 1 | 1 | HEFO reset to inhibit Halt mode release by overflow from the divider circuit. | HEFO |
|  | SC5 | 0000 | 0111 | HEFO $\leftarrow 1$ | 1 | 1 | HEFO set enabling overflow from the divider circuit to release the Halt mode. | HEFO |
|  | RCF | 1111 | 0000 | $\mathrm{CF} \leftarrow 0$ | 1 | 1 | CF reset. | CF |
|  | SCF | 1111 | 0001 | $\mathrm{CF} \leftarrow 1$ | 1 | 1 | CF set. | CF |
|  | LDA | 1010 | 1001 | $\mathrm{AC} \leftarrow[\mathrm{M}(\mathrm{DP})]$ | 1 | 1 | Memory M (DP) contents transferred to AC. |  |
|  | STA | 1010 | 1101 | $\mathrm{M}(\mathrm{DP}) \leftarrow(\mathrm{AC})$ | 1 | 1 | AC contents stored in memory M (DP). |  |
|  | LDI X | 0011 | $\mathrm{x}_{3} \mathrm{x}_{2} \mathrm{x}_{1} \mathrm{x}_{0}$ | $A C \leftarrow X$ | 1 | 1 | Immediate data X loaded to AC. |  |
|  | MVI X | 0010 | $\mathrm{x}_{3} \mathrm{x}_{2} \mathrm{x}_{1} \mathrm{x}_{0}$ | M (DP) $\leftarrow$ X | 1 | 1 | Immediate data X loaded to memory M (DP). |  |

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|  | Mnemonic | Instruction code |  | Function | ¢ | ¢ $\frac{0}{0}$ U |  | Function description | Status <br> flag <br> affected |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { O} \\ & \text { oㄴ } \\ & 0 \\ & 0 \\ & 0 \\ & 0 \\ & 0 \end{aligned}$ | HALT | 0000 | 0000 | CPU operation halts | 1 | 1 | - Halts CPU operation. HALT mode is released under the following conditions. <br> - HALT mode is cancelled by the interaction of SIC X and SC5 commands. |  |  |
|  | SCI X | 110 | $\mathrm{X}_{3} \mathrm{X}_{2} \mathrm{X}_{1} \mathrm{X}_{0}$ | CTL2 $\leftarrow \mathrm{X}$ | 1 | 1 | $\mathrm{X}_{0}$ to $\mathrm{X}_{3}$ Operation. |  | HEF1 to HEF4 |
|  |  |  |  |  |  |  | $\mathrm{X}_{0}$ | HFE1 is set to enable release of HALT mode by overflow signal from divider circuit following CF oscillation circuit. |  |
|  |  |  |  |  |  |  | $\mathrm{X}_{1}$ | HFE2 is set enabling signal rise at input port S to release HALT mode. |  |
|  |  |  |  |  |  |  | $\mathrm{X}_{2}$ | HFE3 is set enabling signal rise at input port M to release HALT mode. |  |
|  |  |  |  |  |  |  | $\mathrm{X}_{3}$ | HFE4 is set enabling 1/10 second pulse to release HALT. |  |
|  | NOP | 1111 | 1111 | No operation | 1 | 1 | No operation. |  |  |
|  | IPS | 1010 | 1111 | $\mathrm{AC} \leftarrow[\mathrm{P}(\mathrm{S})]$ | 1 | 1 | Input data at input port S loaded to AC. |  |  |
|  | IPM | 1010 | 1000 | $\mathrm{AC} \leftarrow[\mathrm{P}(\mathrm{M})]$ | 1 | 1 | Input data at input port M loaded to AC. |  |  |
|  | SPDR X | 111 | $01 \mathrm{X}_{1} \mathrm{X}_{0}$ | PDF $\leftarrow \mathrm{X}$ | 1 | 1 | Pull-down resister MOS-Tr at corresponding input port turned ON/OFF. |  | PDF |
|  |  |  |  |  |  |  | Bit content | Operation |  |
|  |  |  |  |  |  |  | $\mathrm{X}_{0}=0$ | S-Terminal Pull down Tr OFF. |  |
|  |  |  |  |  |  |  | $\mathrm{X}_{0}=1$ | S-Terminal Pull down Tr ON. |  |
|  |  |  |  |  |  |  | $\mathrm{X}_{1}=0$ | M-Terminal Pull down Tr OFF. |  |
|  |  |  |  |  |  |  | $\mathrm{X}_{1}=1$ | M-Terminal Pull down Tr ON. |  |
|  | OUT | 111 | 1100 | (1) Cannot be used when SPC $=0 \& S P=0 \mathrm{H}$ to $\mathrm{CH}, \mathrm{EH}, \mathrm{FH}$. | 1 | 1 | Cannnot be CH, EH, F | e used. (Causes error when OUT is executed at $\mathrm{SPC}=0 \& \mathrm{SP}=0 \mathrm{H}$ to H.) |  |
|  |  |  |  | $\begin{aligned} & \text { (2) } \text { When } \mathrm{SP}=0 \& \mathrm{SP}=\mathrm{D} \\ & \text { CTL3 } \leftarrow(\mathrm{AC}) \end{aligned}$ |  |  | AC content | ts transferred to CTL3. | $\begin{aligned} & \text { CFCF } \\ & \text { CCF } \end{aligned}$ |
|  |  |  |  | (3) When SPC=1 SFR $\leftarrow(\mathrm{AC})$ |  |  | AC content | ts transferred to special function register SFR. |  |
|  | TWRT | 0000 | 0010 | (1) Cannot be used when SPC $=0 \& S P=0 \mathrm{H}$ to $\mathrm{CH}, \mathrm{EH}, \mathrm{FH}$. | 1 | 1 | Cannnot be CH, EH, F | used. (Causes error when TWRT is executed at $\mathrm{SPC}=0 \& \mathrm{SP}=0 \mathrm{H}$ to H.) |  |
|  |  |  |  | (2) When $\mathrm{SPC}=0 \& \mathrm{SP}=\mathrm{D}$ CTL3 $\leftarrow$ ROM |  |  | High-order order 8 bits | 4 bits data of ROM, on current page, addressed by PC whose lows are replaced by AC and $\mathrm{M}(\mathrm{DP})$ contents, is transferred to CTL3. | $\begin{aligned} & \text { CFCF } \\ & \text { CCF } \end{aligned}$ |
|  |  |  |  | (3) When SPC=1 SFR $\leftarrow$ ROM |  |  | High-order whose low to special | 4 bits or 8 bits data of ROM, on the current page, addressed by PC -order 8 bits are replaced by $A C$ and $M$ (DP) contents is transferred unction register SFR |  |
|  | IN | 000 | 0111 | (1) Cannot be used at SPC $=0 \& \mathrm{SP}=0 \mathrm{H}$ to $\mathrm{CH}, \mathrm{EH}, \mathrm{FH}$. | 1 | 1 | Cannnot be CH, EH, F | e used. (Causes error when IN is executed at $\mathrm{SPC}=0 \& \mathrm{SP}=0 \mathrm{H}$ to H.) |  |
|  |  |  |  | (2) When $\mathrm{SPC}=0 \& \mathrm{SP}=\mathrm{D}$ $A C \leftarrow(S T S 3)$ |  |  | STS3 cont | ents transferred to AC. |  |
|  |  |  |  | (3) When SPC=1 AC $\leftarrow($ SFR) |  |  | Special fun | ction register SFR contents transferred to AC. |  |

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|  | Mnemonic | Instruction code |  | Function |  | 軨 | Function description | Status flag affected |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | JMP X | $\begin{array}{rr} 0000 \\ x_{7} x_{6} x_{5} x_{4} & 1 \\ x_{1} \end{array}$ | $\begin{aligned} & 1 x_{10} x_{9} x_{8} \\ & x_{3} x_{2} x_{1} x_{0} \end{aligned}$ | $\left(\mathrm{PC}_{10}\right.$ to $\left.\mathrm{PC}_{0}\right) \leftarrow \mathrm{X}_{10}$ to $\mathrm{X}_{0}$ | 2 | 2 | Loads data specified by $\mathrm{X}_{10}$ to $\mathrm{X}_{0}$ to PC and jumps unconditionally. |  |
|  | BAB0 $X$ | $\begin{array}{cc} 0100 \\ x_{7} x_{6} x_{5} x_{4} & 1 \\ \hline \end{array}$ | $\begin{aligned} & 1 x_{10} x_{9} x_{8} \\ & x_{3} x_{2} x_{1} x_{0} \\ & \hline \end{aligned}$ | $\begin{aligned} & \text { If } \mathrm{AC}_{0}=1 \text { then } \\ & \left(\mathrm{PC}_{10} \text { to } \mathrm{PC}_{0}\right) \leftarrow \mathrm{X}_{10} \text { to } \mathrm{X}_{0} \end{aligned}$ | 2 | 2 | When AC bit 0 is ' 1 ', data specified by $\mathrm{X}_{10}$ to $\mathrm{X}_{0}$ is loaded to PC and jumps. At ' 0 ', PC is incremented +2 . |  |
|  | BAB1 X | $\begin{array}{cc} 0101 & 1 \\ x_{7} x_{6} x_{5} x_{4} & x_{1} \\ \hline \end{array}$ | $\begin{aligned} & 1 x_{10} x_{9} x_{8} \\ & x_{3} x_{2} x_{1} x_{0} \end{aligned}$ | $\begin{aligned} & \text { If } \mathrm{AC}_{1}=1 \text { then } \\ & \left(\mathrm{PC}_{10} \text { to } \mathrm{PC}_{0}\right) \leftarrow \mathrm{X}_{10} \text { to } \mathrm{X}_{0} \\ & \hline \end{aligned}$ | 2 | 2 | When AC bit 1 is ' 1 ', data specified by $\mathrm{X}_{10}$ to $\mathrm{X}_{0}$ is loaded to PC and jumps. At ' 0 ', PC is incremented +2 . |  |
|  | BAB2 X | $\begin{array}{cc} 0110 & 1 \\ x_{7} x_{6} x_{5} x_{4} & x_{1} \\ \hline \end{array}$ | $\begin{aligned} & 1 x_{10} x_{9} x_{8} \\ & x_{3} x_{2} x_{1} x_{0} \end{aligned}$ | $\begin{aligned} & \text { If } \mathrm{AC}_{2}=1 \text { then } \\ & \left(\mathrm{PC}_{10} \text { to } \mathrm{PC}_{0}\right) \leftarrow \mathrm{X}_{10} \text { to } \mathrm{X}_{0} \end{aligned}$ | 2 | 2 | When AC bit 2 is ' 1 ', data specified by $\mathrm{X}_{10}$ to $\mathrm{X}_{0}$ is loaded to PC and jumps. At ' 0 ', PC is incremented +2 . |  |
|  | BAB3 $X$ | $\begin{array}{cc} 0111 \\ x_{7} x_{6} x_{5} x_{4} & 1 \\ \hline \end{array}$ | $\begin{aligned} & 1 x_{10} x_{9} x_{8} \\ & x_{3} x_{2} x_{1} x_{0} \end{aligned}$ | $\begin{aligned} & \text { If } \mathrm{AC}_{3}=1 \text { then } \\ & \left(\mathrm{PC}_{10} \text { to } \mathrm{PC}_{0}\right) \leftarrow \mathrm{X}_{10} \text { to } \mathrm{X}_{0} \end{aligned}$ | 2 | 2 | When AC bit 3 is ' 1 ', data specified by $\mathrm{X}_{10}$ to $\mathrm{X}_{0}$ is loaded to PC and jumps. At ' 0 ', PC is incremented +2 . |  |
|  | BAZ X | $\begin{array}{cc} 0100 & 0 \\ x_{7} x_{6} x_{5} x_{4} & x_{1} \end{array}$ | $\begin{aligned} & 0 x_{10} x_{9} x_{8} \\ & x_{3} x_{2} x_{1} x_{1} x_{0} \end{aligned}$ | $\begin{aligned} & \text { If } \mathrm{AC}=0 \text { then } \\ & \left(\mathrm{PC}_{10} \text { to } \mathrm{PC}_{0}\right) \leftarrow \mathrm{x}_{10} \text { to } \mathrm{x}_{0} \end{aligned}$ | 2 | 2 | When AC is ' 0 ', data specified by $\mathrm{X}_{10}$ to $\mathrm{X}_{0}$ is loaded to PC and jumps. When AC is not ' 0 ', PC is incremented +2 . |  |
|  | BANZ X | $\begin{array}{cc} 0101 & 0 \\ x_{7} x_{6} x_{5} x_{4} & x_{1} \end{array}$ | $\begin{aligned} & 0 x_{10} x_{9} x_{8} \\ & x_{3} x_{2} x_{1} x_{0} \end{aligned}$ | $\begin{aligned} & \text { If } \mathrm{AC} \neq 0 \text { then } \\ & \left(\mathrm{PC}_{10} \text { to } \mathrm{PC}_{0}\right) \leftarrow \mathrm{x}_{10} \text { to } \mathrm{x}_{0} \end{aligned}$ | 2 | 2 | When AC is not ' 0 ', data specified by $\mathrm{X}_{10}$ to $\mathrm{X}_{0}$ is loaded to PC and jumps. When $A C$ is ' 0 ', PC is incremented +2 . |  |
|  | BCNH X | $\begin{array}{cc} 0110 & 0 \\ x_{7} x_{6} x_{5} x_{4} & x_{1} \end{array}$ | $\begin{aligned} & 0 x_{10} x_{9} x_{8} \\ & x_{3} x_{2} x_{1} x_{0} \end{aligned}$ | $\begin{aligned} & \text { If } \mathrm{CF} \neq 1 \text { then } \\ & \left(\mathrm{PC}_{10} \text { to } \mathrm{PC}_{0}\right) \leftarrow \mathrm{X}_{10} \text { to } \mathrm{X}_{0} \end{aligned}$ | 2 | 2 | When CF is ' 0 ', data specified by $\mathrm{X}_{10}$ to $\mathrm{X}_{0}$ is loaded to PC and jumps. When CF is ' 1 ', PC is incremented +2 . |  |
|  | $\mathrm{BCH} \times$ | $\begin{array}{cc} 0111 & 0 \\ x_{7} x_{6} x_{5} x_{4} & x_{1} \end{array}$ | $\begin{aligned} & 0 x_{10} x_{9} x_{8} \\ & x_{3} x_{2} x_{1} x_{0} \end{aligned}$ | $\begin{aligned} & \text { If } \mathrm{CF}=1 \text { then } \\ & \left(\mathrm{PC}_{10} \text { to } \mathrm{PC}_{0}\right) \leftarrow \mathrm{X}_{10} \text { to } \mathrm{X}_{0} \end{aligned}$ | 2 | 2 | When CF is ' 1 ', data specified by $\mathrm{X}_{10}$ to $\mathrm{X}_{0}$ is loaded to PC and jumps. When CF is ' 0 ', PC is incremented +2 . |  |
|  | PAGE | 0001 | 0001 | PAGE $\leftarrow[\mathrm{M}$ (DP)] | 1 | 1 | Memory M (DP) contents loaded to PAGE latch. |  |
|  | JMP* | 0001 | 0000 | $\begin{aligned} & \mathrm{PC}_{10} \text { to } \mathrm{PC}_{08} \leftarrow(\mathrm{PAGE}) \\ & \mathrm{PC}_{07} \text { to } \mathrm{PC}_{04} \leftarrow(\mathrm{AC}) \\ & \mathrm{PC}_{03} \text { to } \mathrm{PC}_{00} \leftarrow[\mathrm{M}(\mathrm{DP})] \end{aligned}$ | 1 | 1 | Unconditionally jumps to page specified by PAGE and address whose loworder 8 bits are specified by contents of AC and memory M (DP). |  |
|  | ROM0 | $\begin{aligned} & 1100 \\ & 0010 \end{aligned}$ | $\begin{aligned} & 1000 \\ & 0000 \end{aligned}$ | $\mathrm{PC}_{11} \leftarrow 0$ | 2 | 2 | Select ROM bank 0. |  |
|  | ROM1 | $\begin{aligned} & 1100 \\ & 0010 \end{aligned}$ | $\begin{aligned} & 1000 \\ & 0001 \end{aligned}$ | $\mathrm{PC}_{11} \leftarrow 1$ | 2 | 2 | Select ROM bank 1. |  |
|  | JSR X | $\begin{array}{cc} 1010 & 0 \\ x_{7} x_{6} x_{5} x_{4} & x_{1} \end{array}$ | $\begin{aligned} & 0 x_{10} x_{9} x_{8} \\ & x_{3} x_{2} x_{1} x_{0} \end{aligned}$ | $\begin{aligned} & \text { STACK } \leftarrow(P C)+2 \\ & \left(\mathrm{PC}_{10} \text { to } \mathrm{PC}_{0}\right) \leftarrow \mathrm{X}_{10} \text { to } \mathrm{X}_{0} \end{aligned}$ | 2 | 2 | Current PC +2 contents are saved in STACK, data specified by $\mathrm{X}_{10}$ to $\mathrm{X}_{0}$ is loaded to PC and sub-routine is called. |  |
|  | RST | 0001 | 0011 | $\mathrm{PC} \leftarrow$ (STACK) | 1 | 1 | Returns PC contents saved in STACK to PC and returns from sub-routine. |  |
|  | SPC0 | $\begin{aligned} & 1100 \\ & 0010 \end{aligned}$ | $\begin{aligned} & 1001 \\ & 0000 \end{aligned}$ | $\mathrm{SPC} \leftarrow 0$ | 2 | 2 | Resets strobe pointer control bit (SPC) to '0'. | SPC |
|  | SPC1 | $\begin{aligned} & 1100 \\ & 0010 \end{aligned}$ | $\begin{aligned} & 1001 \\ & 0001 \end{aligned}$ | $\mathrm{SPC} \leftarrow 1$ | 2 | 2 | Sets strobe pointer control bit (SPC) to '1'. | SPC |
|  | CSEC | 1111 | 1011 | $\phi 11$ to $\phi 15 \leftarrow 0$ | 1 | 1 | Resets high-order 4 bits of divider circuit. | $\begin{aligned} & \hline \text { SCF0 } \\ & \text { SCF4 } \end{aligned}$ |
|  | RWDT | 1111 | 1001 | $($ WDT $) \leftarrow 0$ | 1 | 1 | Resets Watchdog Timer counter. |  |

LC573100 Series Instructions Map

|  | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | A | B | C | D | E | F |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | HALT | TAAT | TWRT | - | CSP | CST | RC5 | SC5 | JMP X |  |  |  |  |  |  |  |
| 1 | JMP* | PAGE | MTR | RTS | - | - | - | IN | ASRO | ASR1 | ASLO | ASL1 | SDPL | SDPH | EDPL | EDPH |
| 2 | MVI X |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| 3 | LDI X |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| 4 | BAZ X |  |  |  |  |  |  |  | BAB0 X |  |  |  |  |  |  |  |
| 5 | BCNH X |  |  |  |  |  |  |  | BAB1 X |  |  |  |  |  |  |  |
| 6 | BCNH X |  |  |  |  |  |  |  | BAB2 X |  |  |  |  |  |  |  |
| 7 | $\mathrm{BCH} X$ |  |  |  |  |  |  |  | BAB3 X |  |  |  |  |  |  |  |
| 8 | ADC | SBC | ADD | SUB | ADN | AND | EOR | OR | ADC* | SBC* | ADD* | SUB* | ADN* | AND* | EOR* | OR* |
| 9 | ADCI | SBCI | ADDI | SUBI | ADNI | ANDI | EORI | ORI | INC | DEC | IDPL | DDPL | IDPH | DDPH | ISP | DSP |
| A | JSR X |  |  |  |  |  |  |  | IPM | LDA | LSP | LHLT | L500 | STA | SSP | IPS |
| B | MDPL X |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| C | MDPH X |  |  |  | - |  |  |  | ROMX | SPCX | - |  |  |  |  |  |
| D | SIC X |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| E | MSP X |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| F | RCF | SCF | NOP | NOP | SPDR X |  |  |  | - | RWDT | - | CSEC | OUT | LDPL | LDPH | NOP |

XXX: 1 Byte-1 Cycle instruction

XXX : 2 Byte-2 Cycle instruction

ROMX : ROM0 instruction $(\mathrm{C} 820 \mathrm{H})$,
ROM1 instruction ( C 821 H )

SPCX : SPC0 instruction (C920H),
SPC1 instruction (C921H)
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[^0]:    Note : CR is 455 kHz , S-PORT : M-PORT : Input lead Tr is ON . RES terminal has resistor built-in and is OPEN. I/O-PORT is set at Output Mode and data is ' H '.

